

184 WLED Matrix Driver with Boost Converter

FEATURES

- High efficiency boost converter with the input voltage range from 2.7 to 5.5 V
- No external Schottky Required (Internal synchronous rectifier)
- 250 mV current sense voltage
- Drives up to 10 LEDs per string
- More than 180 LEDs in matrix
- 0.7 MHz Switching Frequency
- Efficiency greater than 83%
- PWM LED Dimming Control Mode
- Over-voltage, under-voltage, over-current, and over-temperature protection
- Low Shutdown Current ($<1\mu\text{A}$)
- Available in 2 x 3 x 0.8 mm 8-pin TDFN package

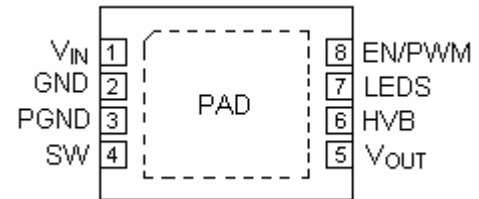
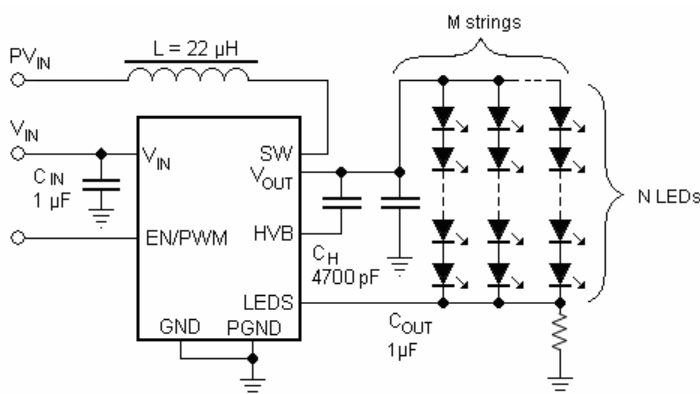
APPLICATION

- Color Display Backlight
- Portable Navigation and GPS Receivers
- Smart phones
- Digital Photo Frames
- Portable DVD Players
- Architectural Lighting

DESCRIPTION

The LDS8720 is a fixed frequency current mode boost converter with internal synchronous rectifier and cycle-by-cycle switch current limit specifically designed to drive matrix of LEDs in respect with the Table 1. Operation at 0.7 MHz allows use of small value low profile inductor ($10 - 33\mu\text{H}$) and $1\mu\text{F}$ 50 V ceramic capacitor.

TYPICAL APPLICATION CIRCUIT



The use of integrated synchronous rectifier makes the efficiency dependent on only inductor DC resistance. Under-voltage protection disables the part when V_{IN} voltage reaches 2.0 V.

PV_{IN} voltage may be set equal V_{IN} voltage or higher up to 15 V to increase power capability of the driver. Maximum number of LEDs in matrix depends on this voltage as shown in the table below.

The LDS8720 has thermal shutdown set at 150°C . Above this value, the boost converter stops switching. The part resumes normal operations when temperature drops below 130°C .

The over-current protection provides cycle-by-cycle current limit.

The internal output over-voltage protection prevents damage in the case of a faulty LED disconnect.

The PWM control ensures brightness adjustment with a frequency from 100 Hz up to 30 KHz.

The EN/PWM logic input functions as a chip enable and LED current PWM control pin.

The device is available in 8-pin TDFN 2 x 3 mm package with a max height of 0.8 mm.

Table 1 Matrix configuration for LDS8720

$PV_{IN\text{ MIN}}, \text{V}$	Number of LED per string	String Current max, mA,	Number of strings
2.7	10	30	1 – 3
3.0	10	30	1 – 4
4.0	10	30	1 – 5
5.0	10	30	1 – 6
7.5	10	30	1 – 9
10	10	30	1 – 12
12.5	10	30	1 – 15
15	10	30	1 – 18
15	8	30	1 – 23

ABSOLUTE MAXIMUM RATINGS

Parameter	Rating	Unit
V_{IN} voltage	6	V
V_{OUT} , SW, LEDS, V_{HVB} voltage	40	V
EN/SET voltage	$V_{IN} + 0.7V$	V
Storage Temperature Range	-65 to +160	°C
Junction Temperature Range	-40 to +125	°C
8-pin TDFN package Thermal Resistance	65	°C/W
Soldering Temperature	300	°C

RECOMMENDED OPERATING CONDITIONS

Parameter	Rating	Unit
V_{IN}	2.7 to 5.5	V
Ambient Temperature Range	-40 to +85	°C

Typical application circuit with external components is shown on page 1.

ELECTRICAL OPERATING CHARACTERISTICS

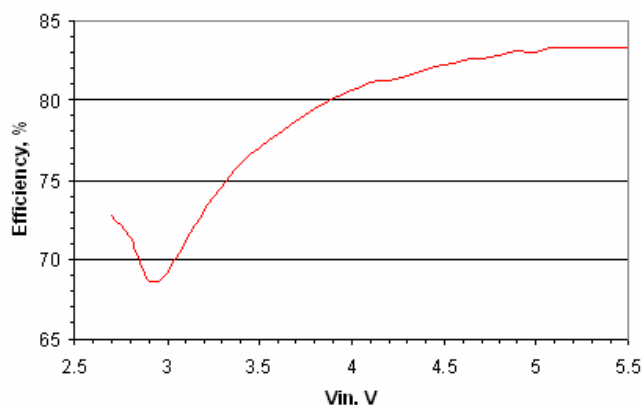
(Over recommended operating conditions unless specified otherwise) $V_{IN} = 3.6V$, $T_{AMB} = 25^{\circ}C$, $C_{IN} = 1\mu F$, $C_{OUT} = 1\mu F$, $L = 22\mu H$

Name	Conditions	Min	Typ	Max	Units
Quiescent Current	$V_{IN} = 3.6V$, V_{OUT} open		1		mA
	$V_{IN} = 3.6V$, $I_{LED} = 25mA$ @ $V_{OUT} = 36V$		3		
Shutdown Current	$V_{IN} = 5.5V$, EN = 0V			1	μA
LED Current Accuracy	At factory preset value		± 3		%
Oscillator Frequency			0.7		MHz
Maximum Duty Cycle			92		%
NMOSFET Switch On Resistance			0.3		Ω
PMOSFET Switch On Resistance			1.5		Ω
Switch Leakage Current				0.1	μA
Switch Current Limit			1.9		A
Dropout/Current sense voltage	At factory preset value		250		mV
PWM Frequency		0.1		30	kHz
EN/PWM Pin	Input Resistance (pull down)		250		k Ω
	Logic Level	High	1.4		V
	Low			0.4	
Thermal Shutdown			150		°C
Thermal Hysteresis			20		
Over-Voltage Protection			36		V
Soft Start Time			1.5		ms
Delay Time to Shutdown	EN = 0		10		ms

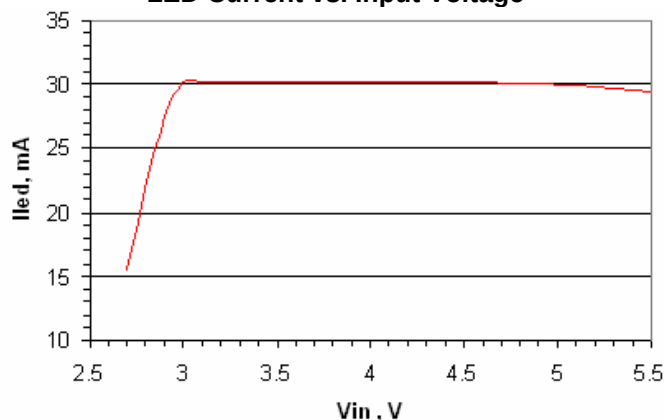
TYPICAL CHARACTERISTICS

$V_{in} = 3.6V$, $I_{OUT} = 30mA$ (1 string with 10 LEDs, $C_{IN} = 1\mu F$, $C_{OUT} = 1\mu F$, $L = 22\mu H$, $T_{AMB} = 25^{\circ}C$ unless otherwise specified)

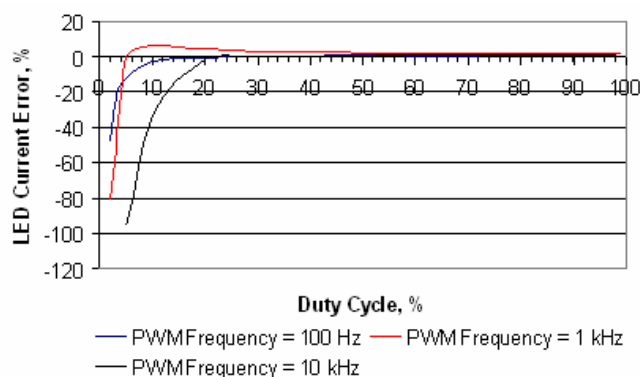
Power Efficiency vs. Input Voltage



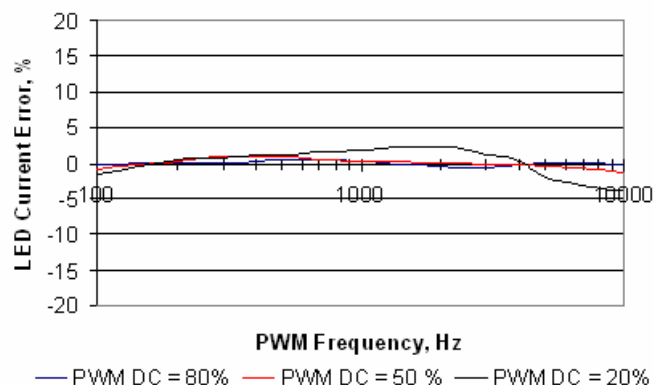
LED Current vs. Input Voltage



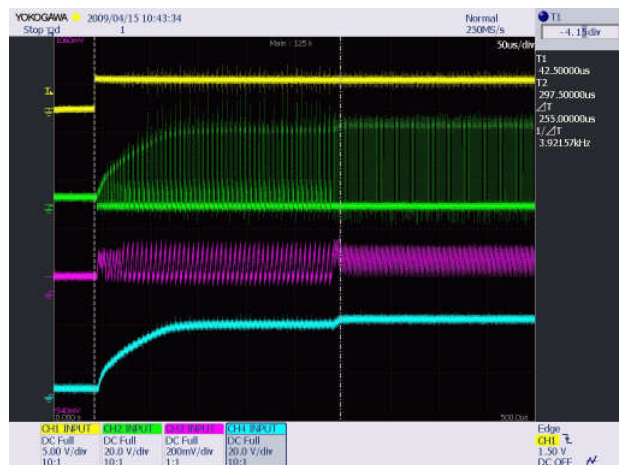
LED Current vs. PWM Duty Cycle



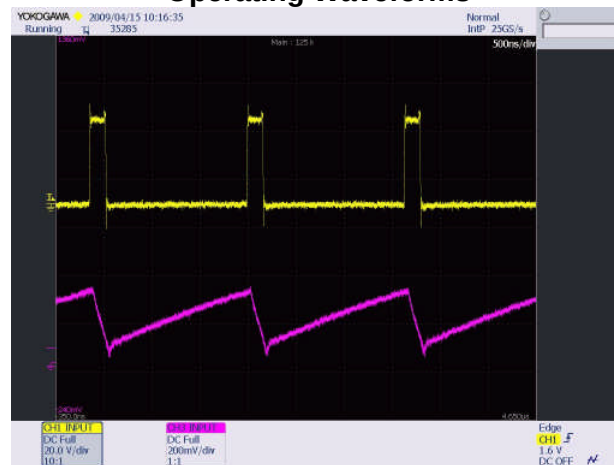
LED Current Error vs. PWM Frequency



Soft Start Waveforms



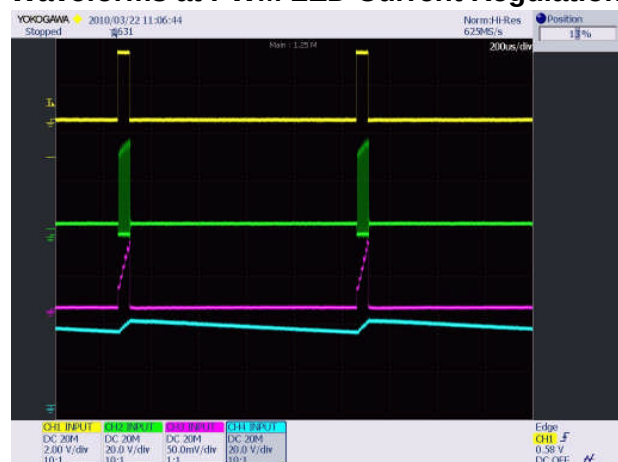
Operating Waveforms



TYPICAL CHARACTERISTICS

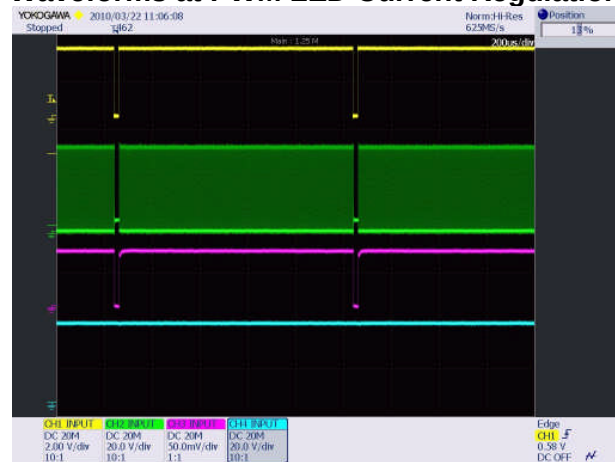
$V_{in} = 3.6V$, $I_{OUT} = 30mA$ (10 LEDs per string), $C_{IN} = 1\mu F$, $C_{OUT} = 1\mu F$, $L = 22\mu H$, $T_{AMB} = 25^{\circ}C$ unless otherwise specified

Waveforms at PWM LED Current Regulation



Ch 1 (yellow) – PWM signal at 1 kHz 5% duty cycle
Ch 2 (green) – SW node voltage, Ch 3 (red) – LED Current.
Ch 4 (blue) – V_{OUT}

Waveforms at PWM LED Current Regulation



Ch 1 (yellow) – PWM signal at 1 kHz 98% duty cycle
Ch 2 (green) – SW node voltage, Ch 3 (red) – LED Current.
Ch 4 (blue) – V_{OUT}

Waveforms at PWM LED Current Regulation



Ch 1 (yellow) – PWM signal at 30 kHz 25% duty cycle
Ch 2 (green) – SW node voltage, Ch 3 (red) – LED Current.
Ch 4 (blue) – V_{OUT}

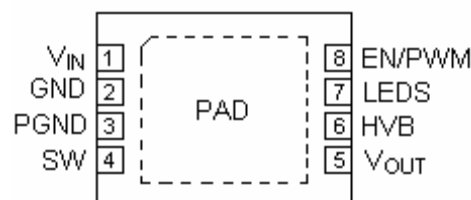
Waveforms at PWM LED Current Regulation



Ch 1 (yellow) – PWM signal at 30 kHz 98% duty cycle
Ch 2 (green) – SW node voltage, Ch 3 (red) – LED Current.
Ch 4 (blue) – V_{OUT}

PIN DESCRIPTION

Pin #	Name	Function
1	V _{IN}	Input Voltage, connect to battery or power supply
2	GND	Analog Ground
3	PGND	Power Ground
4	SW	Switch input; Connect inductor terminal to this pin
5	V _{OUT}	Output voltage; Connect the LED string anode terminal to this pin.
6	HVB	High Voltage Bypass; Connect a 470 pF capacitor between this point and V _{OUT}
7	LEDS	Current Sense input. Connect LED string cathode terminal to this pin
8	EN/PWM	Device Enable (active high) and Dimming Control
PAD	PAD	Connect to GND on the PCB



Top view: TDFN 8-lead 2 X 3 mm

PIN FUNCTION

V_{IN} is the supply pin for the driver. A small 1 μ F ceramic bypass capacitor is required between the V_{IN} pin and ground near the device. The operating input voltage range is from 2.7 V to 5.5 V. If the input supply voltage falls below the under-voltage threshold, switch is disabled, and the device enters shutdown mode.

HVB is the internal high voltage reference point. Connect a 4700 pF capacitor between this point and V_{OUT}.

EN/PWM is the enable and PWM control logic input. Guaranteed levels of logic high and logic low are set at 1.4 V and 0.4 V respectively. When EN/PWM is initially taken high, the device becomes enabled and LED current sets to maximum programmed value.. To place the device into shutdown mode, the EN/PWM pin must be held low for more than 10 ms.

V_{OUT} is the driver output. Connect it to the LED anode. A ceramic bypass capacitor of 1 μ F requires between the V_{OUT} pin and ground near the device.

GND is the ground reference for the analog circuits. The pin must be connected to the ground plane on the PCB. Avoid high currents flowing trough traces connecting this pin with EN/PWM signal source.

PGND is the current return for high current circuits. The pin must be connected to the ground plane on the PCB. Connect GND and PGND as close to the driver as possible.

LEDS is the Current Sense pin that provides internal regulated current sink for LED string. Connect LED string cathode to this pin. This pin enter high-impedance zero current state whenever the device is in shutdown mode.

PAD is the exposed pad underneath the package. For best thermal performance, the pad should be soldered to the PCB and connected to the ground plane

BLOCK DIAGRAM

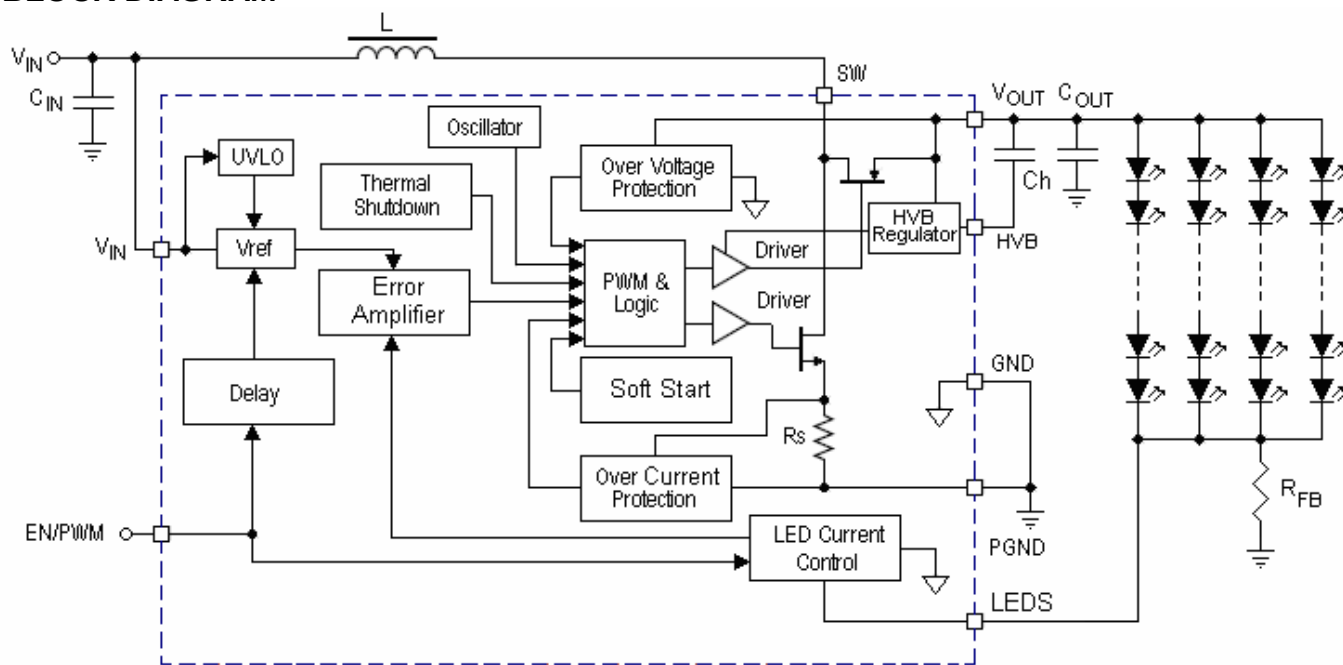


Figure 2. LDS8720 Functional Block Diagram

BASIC OPERATION

At power-up, EN/PWM pin should be logic LOW. The LDS8720 starts operating when EN/PWM pin is asserted logic high. If the input voltage is sufficient to regulate all LED currents, the device remains in operating mode. The low dropout Current regulator performs well at V_{OUT} voltage up to 250 mV above summary LED forward voltage significantly increasing driver's efficiency.

If the input voltage is insufficient or falls to a level where the regulated currents cannot be maintained, the Under-Voltage protection turns device off setting it in shutdown mode.

The LDS8720 has soft start function that prevent high input current spike at device' wake-up.

The EN/PWM pin should be held low for more than 10 ms to completely turn device in low current shutdown mode.

LED Current Setting

The maximum current sink value in the LEDS pin is factory preset at 30 mA. An external resistor R_{FB} should be used to bypass current if more than one string is connected. $R_{FB} = 0.25 \text{ V} / (I \times M - 0.03)$, ohms, where 0.25 V is a feedback voltage, I – is current value per string in amperes, and M is number of strings connected in parallel.

Power dissipated at R_{FB} is equal $W = 0.0625/R_{FB}$, watt.

In case of three strings with 25 mA current per string $R_{FB} = 0.25/(0.025 \times 3 - 0.03) = 5.6 \, \Omega$, and dissipated power $W = 0.0625/5.6 = 0.011 \, W$.

The average LED string current that determines LED brightness may be controlled applying PWM signal to the EN/PWM pin. The maximum PWM frequency is 30 kHz, while frequencies below 100 Hz are not recommended to avoid visible LED flickering. Duty cycle that determines average LED string current may vary in the range from 5% to 100% at 1 kHz or from 20% to 100% at 30 kHz with high linearity current regulation.

Protection Mode

The output voltage V_{OUT} is limited at about 36 V. This is to prevent the output pin from exceeding its absolute maximum rating if LED string is disconnected or any LED in string burns out creating open circuitry.

If the die temperature exceeds +150°C, the driver will enter a thermal protection shutdown mode. When the device temperature drops by about 20°C, the device will resume normal operation.

If the input supply voltage falls below the under-voltage threshold, switch is disabled, and the device enters shutdown mode.

LED Selection

The number of the LEDs in string is limited by maximum output voltage that cannot exceed over-voltage protection level. We recommend using not more than 10 LEDs with $V_F \leq 3.6$ V in string if V_{IN} voltage is above 3.0 V and not more than 8 LEDs if V_{IN} may fall up to 2.7 V.

External Components Selection

The LDS8720 requires four external components only. The recommended input capacitor value is between 1.0 and 10uF, while the output capacitor selection is function of desired output ripple, loop stability, and inrush current. We recommend $C_{OUT} = 1 \mu F$.

The inductor should allow around 20% higher peak current than LDS8720 Switch Current Limit I_{LIM} (see table *Electrical Operating Characteristics* on page 2).

However, the maximum ripple current through inductor I_R should not exceed

$$I_R = 2 \left(I_{LIM} - \frac{I_{LED} (NV_F + V_d)}{V_{IN} \eta} \right), \text{ where}$$

V_F - is a LED forward voltage, V

N - is number of LEDs per string

V_d - is a current regulator voltage drop = 0.2 V,

V_{IN} - is an input voltage, V

We recommend continuous conduction mode for inductor to achieve highest efficiency. That limits I_R value as

$$I_R < \frac{2I_{LED} (NV_F + V_d)}{\eta V_{IN}}$$

Inductor value L is a function of switching frequency, input and output voltage and is determined by following equation:

$$L = \frac{1}{I_R f \left(\frac{1}{NV_F + V_d + V_{PM} - V_{IN}} + \frac{1}{V_{IN}} \right)}, \text{ where}$$

V_{PM} - is a voltage drop across synchronous rectifier (PMOSFET) = 1.5 ohms $\times I_{LED}$, (A),

L - is an inductance, H, and
 f - is a switching frequency, 700 kHz.

Inductor should have minimum DC resistance to avoid driver's efficiency degradation.

The equation for the output capacitor selection is:

$$C_{OUT} = \frac{(NV_F + V_d - V_{IN}) I_{OUT}}{(NV_F + V_d) V_R f}, \text{ where}$$

V_R - is a ripple voltage at the output.

For example:

If $V_{IN} = 2.7$ V, $N = 9$, $V_F = 3.3$ V, $V_d = 0.25$ V, $f = 0.7$ MHz, $I_{OUT} = 90$ mA, (3 strings in parallel $\times$ 30 mA) and ripple voltage $V_R = 0.1$ V, $C_{OUT} = 0.83 \mu F$ so $1 \mu F$ is a good choice.

We recommend $C_{OUT} = 1 \mu F$ to achieve better efficiency and driver's stability.

Recommended Layout

In active mode, the driver switches internally at a high frequency. We recommend minimize trace length to all external capacitors and inductor. The input and output ceramic capacitors (X5R or X7R type) should located as close to the device' pins as possible to prevent from EMI distribution

A ground plane should cover the area under the driver IC as well as the bypass capacitors. Short connection to ground on capacitors C_{IN} and C_{OUT} can be implemented with the use of multiple via. A copper area matching the TDFN exposed pad (PAD) must be connected to the ground plane underneath. The use of multiple via improves the package heat dissipation.

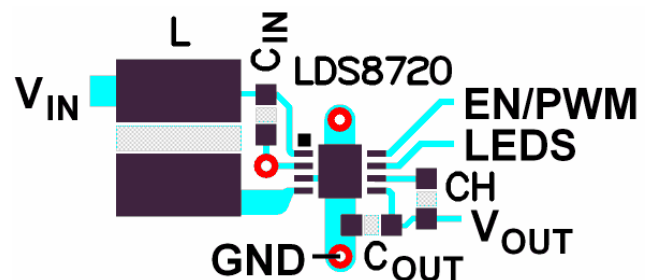
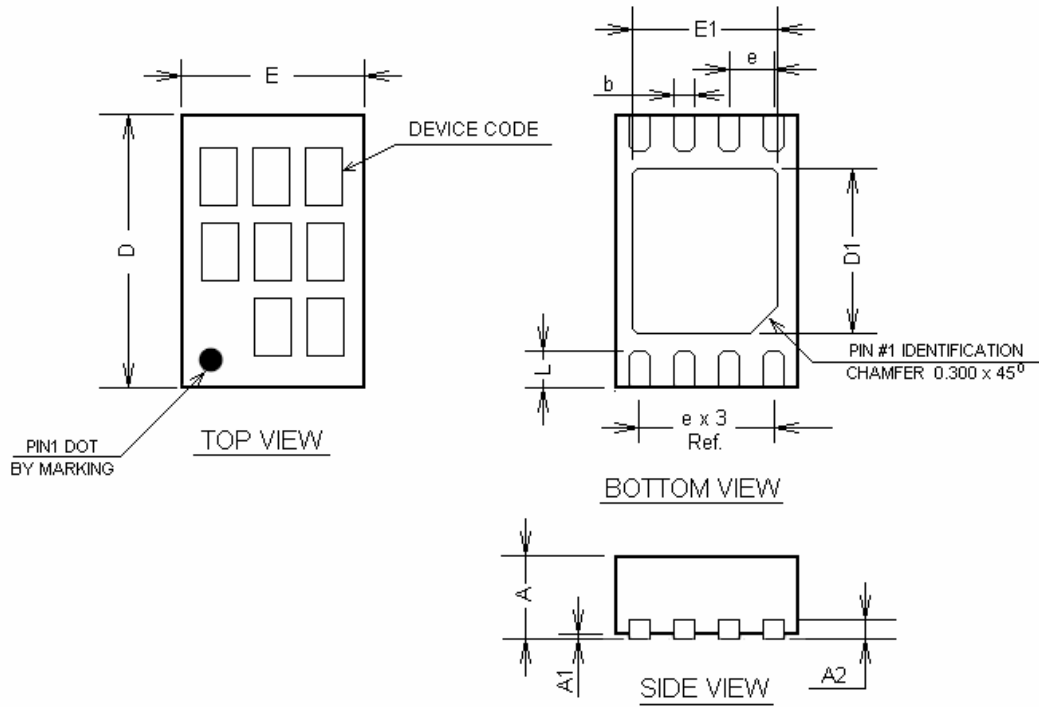


Figure 3. Recommended layout

PACKAGE DRAWING AND DIMENSIONS

8-PIN TDFN, 2mm x 3mm, 0.5mm PITCH



SYMBOL	MIN	NOM	MAX
A	0.700	0.750	0.800
A1	-	0.000	0.050
A2		0.203 Ref.	
b	0.180	0.230	0.280
D	2.950	3.000	3.050
D1	1.750	1.800	1.850
E	1.950	2.000	2.050
E1	1.550	1.600	1.650
e		0.500 Bsc	
L	0.350	0.400	0.450

Note:

1. All dimensions are in millimeters
2. Complies with JEDEC Standard MO-220

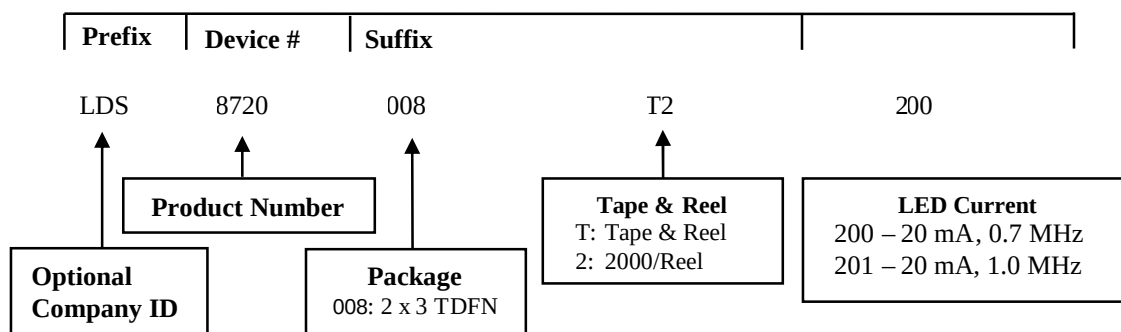
ORDERING INFORMATION

Part Number	Package	Package Marking
LDS8720 008-T2 ¹⁾ – 200 ²⁾	TDFN - 8 2 x 3mm ³⁾	720

Notes:

1. Quantity per reel is 2000
2. Maximum LED current is factory preset at 20 mA. Consult factory if other current values are required.
3. Matte-Tin Plated Finish (RoHS-compliant)

EXAMPLE OF ORDERING INFORMATION



Notes:

- 1) All packages are RoHS-compliant (Lead-free, Halogen-free).
- 2) The standard lead finish is Matte-Tin.
- 3) The device used in the above example is a LDS8720 XXX–T2-200 (2x3 TDFN, Tape & Reel, 20 mA LED Current, 0.7 MHz switching frequency).
- 4) For additional package and current options, please contact your nearest IXYS Corp. Sales office.

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